



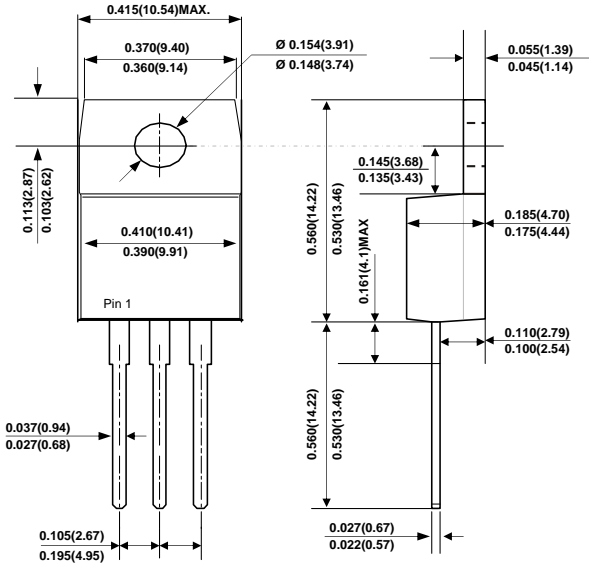
MUR1605CT THRU MUR1660CT

SUPER FAST RECOVERY RECTIFIER

Reverse Voltage - 50 to 600 Volts Forward Current - 16.0 Ampere

TO-220AB

FEATURES



Dimensions in inches and (millimeters)

- ◆ Plastic package has Underwriters Laboratory Flammability Classification 94V-0. Flame Retardant Epoxy Molding Compound.
- ◆ Exceeds environmental of MIL-S-19500/228
- ◆ Low power loss, high efficiency.
- ◆ Low forward voltage, high current capability.
- ◆ High surge capability.
- ◆ Super fast recovery times, high voltage.
- ◆ Epitaxial chip construction.
- ◆ In compliance with EU RoHS 2002/95/EC directives.

MECHANICAL DATA

Case: TO-220AB, Molded plastic.

Terminals: Solderable per MIL-STD-750 · Method 2026

Weight: 1.859 gram (0.0655 ounces).

Standard Packaging : Tube.

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

PARAMETER	SYMBOLS	MUR1605CT	MUR1610CT	MUR1615CT	MUR1620CT	MUR1630CT	MUR1640CT	MUR1660CT	UNITS	
Maximum Recurrent Peak Reverse Voltage	V _{RRM}	50	100	150	200	300	400	600	Volts	
Maximum RMS Voltage	V _{RMS}	35	70	105	140	210	280	420	Volts	
Maximum DC Breakdown Voltage	V _{DC}	50	100	150	200	300	400	600	Volts	
Maximum Average Forward Current at T _C =90°C	I _{F(AV)}	16.0							Amp	
Peak Forward Surge Current, 8.3ms single half sinewave superimposed on rated load(JEDEC methode)	I _{FSM}	125							Amps	
Maximum Forward Voltage at 8A	V _F	0.95			1.30		1.70		Volts	
Maximum DC Reverse Current at T _J =25°C Rated DC Blocking Voltage T _J =100°C	I _R	1.0 500							μA	
Maximum Reverse Recovery Time (NOTE 2)	t _{rr}	35				50				ns
Typical Junction Capacitance (NOTE 1)	C _J	62							pF	
Typical Thermal Resistance	R _{θJC}	3.0							°C/W	
Operating and Storage Temperature Range	T _{STG}	-50 ~ +150							°C	

- Note:**
1. Measured at 1MHz and applied reverse voltage of 4.0V D.C.
 2. Reverse Recovery Test Conditions: I_F=0.5A, I_R=1A, I_{rr}=0.25A.
 3. Both Bonding and Chip structure are available.



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RATINGS AND CHARACTERISTIC CURVES

FIG. 1- FORWARD CURRENT DERATING CURVE

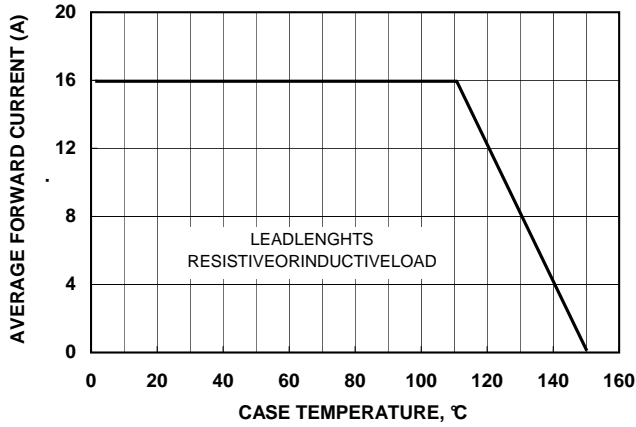


FIG. 2-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

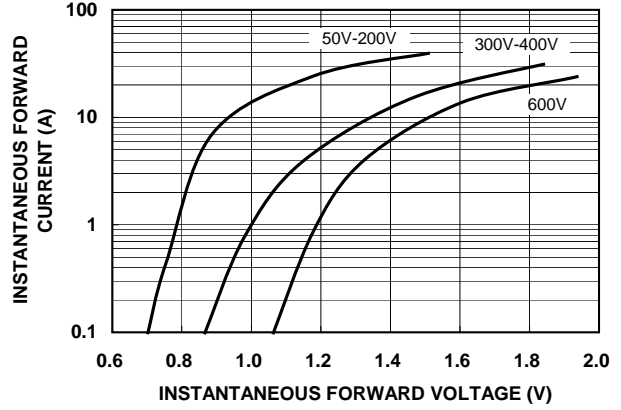


FIG. 3-TYPICAL REVERSE CHARACTERISTICS

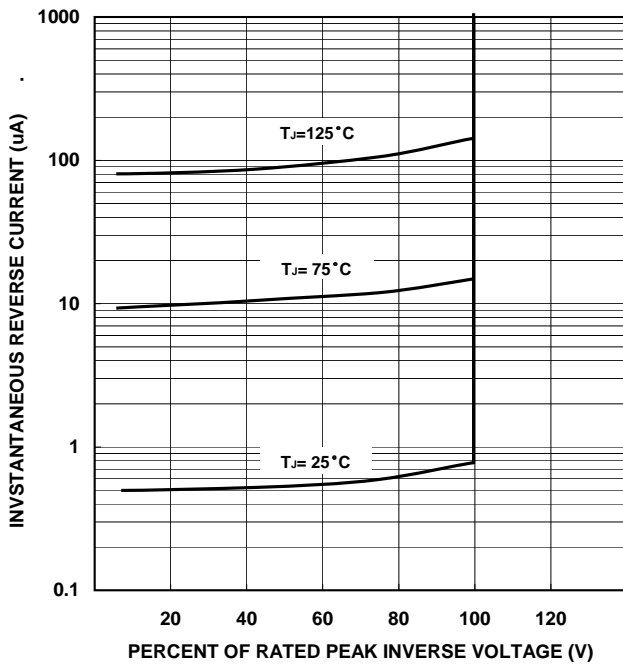


FIG. 4-MAXIMUM NON-REPETITIVE SURGE CURRENT

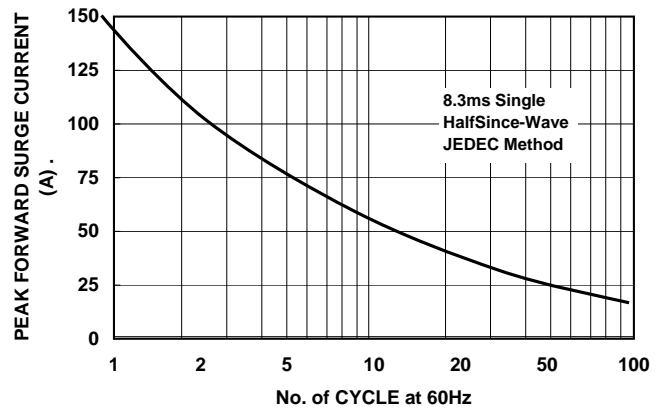


FIG. 5-TYPICAL JUNCTION CAPACITANCE

